Patent and Trademark Office			
To the Honorable Commissioner of Patents 102688295dd original documents or copy thereof.			
1	Name of conveying party(ies):	2	Name and address of receiving party(ies):
	JINN-YEH CHIEN		Taiwan Semiconductor Manufacturing Co. Ltd. No. 8. Li-Hsin Rd. 6 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.
3	Nature of conveyance: ■ Assignment		Additional name(s) & address(es) attached □ Yes ☒ No
4	Execution Date: November 24, 2003 Application number(s) or patent number(s): 78 If this document is being filed together with a new application,		execution date of the application is:11/24/2003
	A. Patent Application No(s).		B. Patent No(s)
Additional numbers attached? □ Yes ⊠ No			
5	Name and address of party to whom correspondence concerning document should be mailed:	6	Total number of applications and patents involved:
	RANDY W. TUNG Tung & Associates	7	Total fee (37 CFR 3.41) \$40.00
	838 W. Long Lake Road Suite 120		□ Enclosed ☑ Authorized to charge credit card (w/filing fee)
	Bloomfield Hills, Michigan 48302	8	Deposit Account Number: (Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE			
9 Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Randy W. Tung Name of Person Signing Registration No. 31,311 Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Date			
Total number of pages including cover sheet, attachments, and document : 3 Commissioner for Patents			
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03-09-2004

67,200-0959

P.O. Box 1450
Alexandria, VA 22313-1450

03/04/2004 AADDF01 00000029 10789300

03 FC:**80**21

40.00 DF

PATENT REEL: 015034 FRAME: 0186

ASSIGNMENT

WHEREAS, I, JINN-YEH CHIEN, have invented certain improvements in

ON-CHIP TEST APPARATUS

for which I am about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of

No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of

acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and

valuable consideration, the receipt of which is hereby acknowledged, I, JINN-YEH CHIEN, by these

presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory

of the United States of America and all foreign countries, the entire right, title and interest, including

all priority rights under the International Convention associated with each country of the Union, in

and to said invention as described in the patent application executed by me on the 24 day of

November, 2003, preparatory to obtaining Letters Patent of the United States thereon,

and in and to said application and any Letters Patent that may be granted in pursuance of said

application and any divisional, continuation or continuation-in-part application thereof, and in and

to any reissue of any such patent, and in and to any patent applications which may be filed on said

invention in countries foreign to the United States and any Letters Patent granted thereon.

1

PATENT REEL: 015034 FRAME: 0187 67,200-959 2002-0410

I further authorize said corporation to apply for foreign patents on said invention in

its own name or through its designees, including subsidiaries, related companies or assignees, under

the International Convention or otherwise, and I further agree to execute all papers, including those

required for the United States and foreign applications, and to perform such other proper acts as said

corporation or its designees the rights herein assigned.

Jim - Yeh Chien
JINN-YEH CHIEN

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120

RECORDED: 02/26/2004

Bloomfield Hills, Michigan 48302

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PATENT REEL: 015034 FRAME: 0188